

EMIF02-USB03F2

2-line IPAD™, EMI filter including ESD protection

Features

- 2-line, low-pass filter + 2-line ESD protection
- High efficiency in EMI filtering
- Lead-free package
- Very low PCB space occupation: < 2.80 mm²</p>
- Very thin package: 0.65 mm
- High efficiency in ESD suppression (IEC 61000-4-2 level 4)
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

Complies with the following standards

- IEC 61000-4-2 level 4 on external pins:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-2 level 1 on internal pins:
 - 2 kV (air discharge)
 - 2 kV (contact discharge)

Application

ESD protection and EMI filtering for:

■ USB OTG port

Description

The EMIF02-USB03F2 is a highly integrated array designed to suppress EMI / RFI noise for USB OTG (on-the-go) ports.

The EMIF02-USB03F2 Flip-Chip packaging means the package size is equal to the die size.

Additionally, this filter includes ESD protection circuitry which prevents damage to the protected device when subjected to ESD surges up to 15 kV on external contacts.

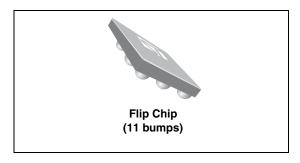


Figure 1. Pin layout (bump side)

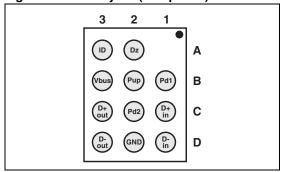
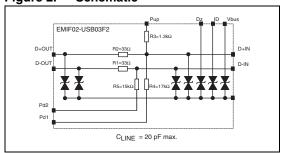


Figure 2. Schematic



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Characteristics EMIF02-USB03F2

1 Characteristics

Table 1. Absolute ratings ($T_{amb} = 25 \,^{\circ}C$)

Symbol	Parameter and test conditions	Value	Unit
	Internal pins (D3, C3, C2, B2, B1):		
V _{PP}	ESD discharge IEC61000-4-2, air discharge	2	
	ESD discharge IEC61000-4-2, contact discharge	2	kV
	External pins (D1, C1, A2, A3, B3):		ΚV
	ESD discharge IEC61000-4-2, air discharge	15	
	ESD discharge IEC61000-4-2, contact discharge	8	
Tj	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	-40 to +85	°C
T _{stg}	Storage temperature range	-55 to 150	°C

Table 2. Electrical characteristics ($T_{amb} = 25$ °C)

Symbol	Parameters				
V_{BR}	Breakdown voltage			† I	
I _{RM}	Leakage current @ V _{RM}				
V _{RM}	Stand-off voltage		.,		
V _{CL}	Clamping voltage	V _{CL} V _{BR}	V _{RM}	I _{RM}	→ v
R _d	Dynamic impedance			I _R	
I _{PP}	Peak pulse current	slope	: 1 / Rd		
C _{LINE}	Input capacitance per line			· I _{PP}	
Symbol	Test conditions	Min	Тур	Max	Unit
V _{BR}	I _R = 1 mA	14			V
I _{RM}	V _{RM} = 3 V			0.2	μΑ
C _{LINE}	V _{LINE} = 0 V, V _{OSC} = 30 mV, F = 1 MHz, measured in zero light condition			20	pF
R ₁ , R ₂	Tolerance ± 5 %		33		Ω
R ₃	Tolerance ± 5 %		1.30		kΩ
R ₄	Tolerance ± 5 %		17		kΩ
R ₅	Tolerance ± 5 %		15		kΩ

EMIF02-USB03F2 Characteristics

Figure 3. Filtering measurement

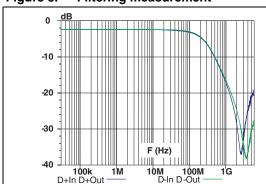


Figure 4. Analog crosstalk measurement

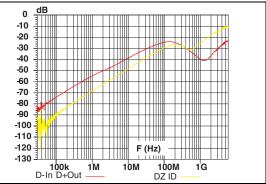
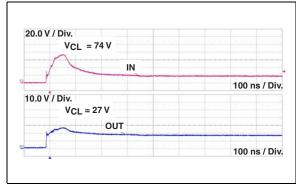


Figure 5. ESD response to IEC 61000-4-2 (+15 kV air discharge) on one input V_{in} and on one output V_{out}

Figure 6. ESD response to IEC 61000-4-2 (-15 kV air discharge) on one input V_{in} and on one output V_{out}



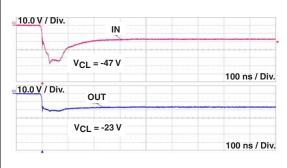
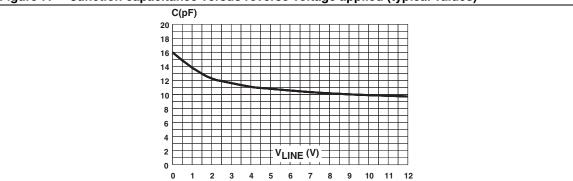


Figure 7. Junction capacitance versus reverse voltage applied (typical values)



2 Application information

Figure 8. Application schematic

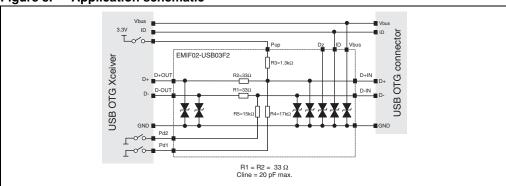


Figure 9. Aplac model

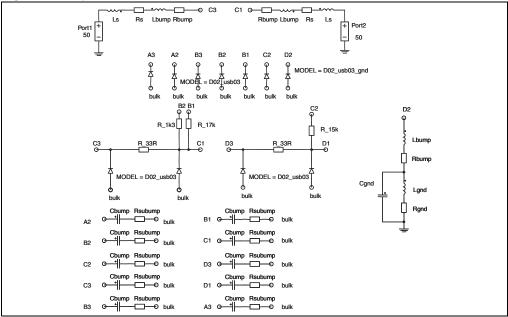


Figure 10. Aplac parameters

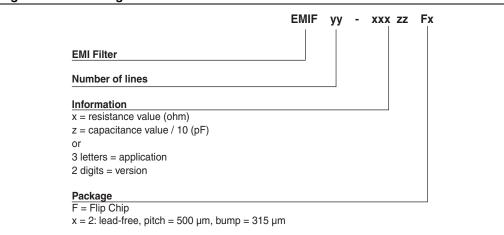
```
Ls 950pH
                         Rs_usb03_gnd 0.9
                         Lgnd 50pH
Rs 150m
R_33R 33
                         Rgnd 100m
R_1k3 1.3k
                         Cgnd 0.15pF
R_15k 15k
                         Lbump 50pH
R_17k 17k
                         Rbump 20m
Cz_usb03 11pF
                         Cbump 2.4pF
Rs_usb03 1
                         Rsubump 100m
Cz_usb03_gnd 220pF
```

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3 Ordering information scheme

Figure 11. Ordering information scheme



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 12. Package dimensions

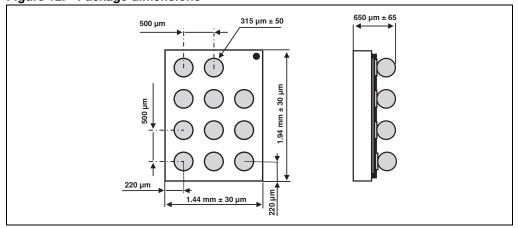


Figure 13. Footprint

Figure 14. Marking

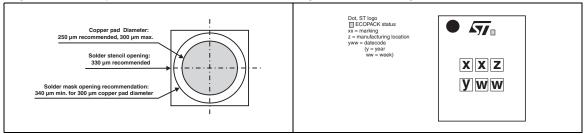
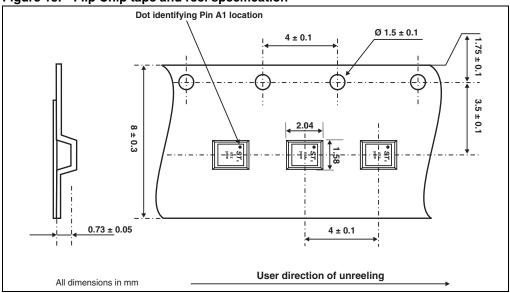


Figure 15. Flip Chip tape and reel specification



Note:

More information is available in the application notes:

AN1235: "Flip Chip: Package description and recommendations for use"

AN1751: "EMI filters: Recommendations and measurements"

5 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF02-USB03F2	FU	Flip Chip	4 mg	5000	Tape and reel 7"

EMIF02-USB03F2 Revision history

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
14-Oct-2004	1	Initial release.
25-Oct-2004	2	Figure 14.: Flip Chip marking dimensions updated.
27-Oct-2004	3	Minor layout update. No content change.
28-Apr-2008	4	Updated ECOPACK statement. Updated <i>Figure 11</i> , <i>Figure 12</i> , <i>Figure 13</i> , <i>Figure 14</i> and <i>Figure 15</i> . Reformatted to current standards.
08-Feb-2010	5	Updated the maximum value of I _{RM} in <i>Table 2</i> . Updated <i>Figure 12</i> and <i>Figure 15</i> for die dimension reductions.

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